| In re U.S. Patent Application of SHIMANUKI et al. O 1 1 2 2 2003 2 3 3 3 3 3 3 3 3 3 3 3 3 3 3 | | | |
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| SHIMANUKI et al. SHIMANUKI et al. Unit: 2827 | | | |
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| Application Number: 10/091,302 Examiner | | | |
| Filed: March 6, 2002) Zarneke, Davi | vid A. | | |
| For: A MANUFACTURING METHOD OF A SEMICONDUCTOR DEVICE) | | | |
| ATTORNEY DOCKET No. HITA.0176 | | | |
| | | | |
| Honorable Assistant Commissioner for Patents Washington, D.C. 20231 | | | |
| COVER LETTER Sir: | | | |
| [] The fee for submission of additional claims is calculated as shown below: | • | | |
| FOR TOTAL WITH TOTAL CLAIMS PAID RATE CONTROL CURRENTLY ON FILE | CALCULATION | | |
| Total Claims 4 80 60 (Over 20) x \$18 | | | |
| Independent 1 4 1 (Over 3) x \$84 | | | |
| MULTIPLE DEPENDENT CLAIM(S) + \$280 | 0 | | |
| REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED | , | | |
| TOTAL : | 138.00 | | |
| In addition, the below-identified communications are submitted in the above-captioned a proceeding: [x] Response to Office Action | | | |

| l J | for A duplicate copy of this paper is enclosed. |
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| [] | A check in the amount of \$0.00 to cover the excess claims fee is enclosed. |
| [x] | The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to Deposit Account Number 08-1480 . |
| | Respectfully submitted. Stanley P. Pisher Registration Number 24,344 |
| ~~~ | Juan Carlos A. Marquez Registration Number 34,072 |

REED SMITH LLP

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July 24, 2003